



LC867248A/40A/32A/24A

8-Bit Single Chip Microcontroller

Preliminary

Overview

The LC867248A/40A/32A/24A microcontrollers are 8-bit single chip microcontrollers with the following on-chip functional blocks :

- CPU : Operable at a minimum bus cycle time of 0.5 μ s (microsecond)
- On-chip ROM maximum capacity : 48K bytes
- On-chip RAM capacity : 1152 bytes
- LCD controller/driver
- Two 16-bit timers (or four 8-bit timers)
- 8-channel \times 8-bit AD converter
- Two 8-bit synchronous serial-interface circuits
- 13-source 10-vectored interrupt system

All of the above functions are fabricated on a single chip.

Features

(1) Read Only Memory (ROM)	: LC867248A	49152 \times 8 bits
	: LC867240A	40960 \times 8 bits
	: LC867232A	32768 \times 8 bits
	: LC867224A	24576 \times 8 bits

(2) Random Access Memory (RAM) : 1152 \times 8 bits

(3) Bus Cycle Time/Instruction Cycle Time

Bus cycle time	cycle time	Clock divider	System clock oscillation	Oscillation Frequency	Voltage
0.5 μ s	1.0 μ s	1/1	Ceramic resonator oscillation	6MHz	4.5 - 6.0V
2 μ s	4.0 μ s	1/2	Ceramic resonator oscillation	3MHz	2.5 - 6.0V
7.5 μ s	15.0 μ s	1/2	RC resonator oscillation	800kHz	2.5 - 6.0V
183 μ s	366 μ s	1/2	Crystal oscillation	32.768kHz	2.5 - 6.0V

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(4) Ports

- Input / output ports : 70 terminals (normal ports P0, P1, P3, PA, PB, PC, PD, PE, PF)
 - P0 Input/output port programmable in nibble units : 1 port (8 terminals)
(When the N-channel open drain output is selected, the data in a bit can be inputted.)
 - P1 Input/output port programmable in a bit : 1 port (8 terminals)
 - P3 Input/output port programmable in a bit : 1 port (6 terminals)
 - PA, PB, PC, PD, PE, PF (can be used for LCD)
Input/output port programmable in two bits : 6 ports (48 terminals)
- Input ports : 21 terminals (P7, P8, PL)
- LCD control port : 52 terminals
 - Segment output port : 48 terminals
 - Common output port : 4 terminals

(5) LCD controller / driver

- Selectable seven kinds of display mode (a combination of static 1/2, 1/3, 1/4 duty and 1/2, 1/3 bits)
- The segment and common output ports can be switched to a general input/output port.

(6) AD converter

- 8-channel × 8-bit AD converter

(7) Serial-interface

- One channel × 16-bit serial-interface circuits (8-bit transmission available by program)
- LSB first/MSB first function available
- Internal 8-bit baud-rate generator in common with two serial-interface circuits

(8) Timers

- Timer0
 - 16-bit timer / counter
 - 2-bit prescaler + 8-bit programmable prescaler
 - Mode 0 : Two 8-bit timers with programmable prescaler
 - Mode 1 : 8-bit timer with programmable prescaler + 8-bit counter
 - Mode 2 : 16-bit timer with programmable prescaler
 - Mode 3 : 16-bit counter
 - The resolution of Timer is tCYC. (tCYC : cycle time)
- Timer1
 - 16-bit timer / PWM
 - Mode 0 : Two 8-bit timers
 - Mode 1 : 8-bit timer + 8-bit PWM
 - Mode 2 : 16-bit timer
 - Mode 3 : Variable-bit PWM (9-16 bits)
 - In Mode 0 and Mode 1, the resolution of Timer and PWM is tCYC.
 - In Mode 2 and Mode 3, the resolution of Timer and PWM selectable ; tCYC or 1/2tCYC by program
- Base timer
 - Every 500ms overflow system for a clock application (using 32.768kHz crystal oscillation for Base timer clock)
 - Every 976μs, 3.9ms, 15.6ms, 62.5ms overflow system (using 32.768kHz crystal oscillation for Base timer clock)
 - The Base timer clock selectable ; 32.768kHz crystal oscillation, System clock, and programmable prescaler output of Timer 0

(9) Buzzer output

- The Buzzer sound frequency selectable ; 4KHz, 2KHz (using 32.768kHz crystal oscillation for Base timer clock)

(10) Remote control receiver circuit (Shares with the P73/INT3/T0IN terminal)

- Noise rejection
- Switch polarity function

(11) Watchdog timer

- The watchdog timer is taken on RC outside
- Watchdog timer operation selectable : interrupt system, system reset

(12) Interrupts system

- 13-source 10-vectored interrupts :
 1. External interrupt INT0 (include watchdog timer)
 2. External interrupt INT1
 3. External interrupt INT2, timer / counter T0L (Lower 8-bit)
 4. External interrupt INT3, base timer
 5. Timer / counter T0H (Upper 8-bit)
 6. Timer T1L, Timer T1H
 7. Serial interface SIO0
 8. Serial interface SIO1
 9. AD converter
 10. Port 0
- Built-in interrupt priority control register

Microcontroller allows 3 levels of interrupt; low level, high level, and highest level of multiplex interrupt. It can specify a low level or a high level interrupt priority from INT2/T0L through port 0 (i.e. the above interrupt number from three through ten). It can also specify a low level or the highest level interrupt priority to INT0 and INT1.

(13) Real-time service operation

The Real-time service (RTS) functions the 4-byte data-transfer between the special function registers at acknowledging the interrupt request.

The RTS starts within 1 instruction cycle-time and completes within 5 instruction cycle-times after occurring the interrupt request.

(14) Sub-routine stack levels

- 128 levels (Max.) : stack area included in RAM area

(15) Multiplication and division

- 16-bit \times 8-bit (7 instruction cycle times)
- 16-bit \div 8-bit (7 instruction cycle times)

(16) Three oscillation circuits

- On-chip RC oscillation circuit using for the system clock
- On-chip CF oscillation circuit using for the system clock
- On-chip crystal oscillation circuit using for the system clock and for time-base clock

(17) Standby function

- HALT mode function

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This operation mode can be released by the interrupt request signals or the system reset request signal.

- HOLD Mode function

The HOLD mode is used to freeze all the oscillations ;

RC (internal), CF and Crystal oscillations. This mode can be released by the following operations.

- Reset terminal (RES) set to low level.
- Input a assigned level to P70/INT0 or P71/INT1 terminal
- Input a Port0 interrupt condition

(18) Factory shipment

- QFP100E delivery form

(19) Development support tools

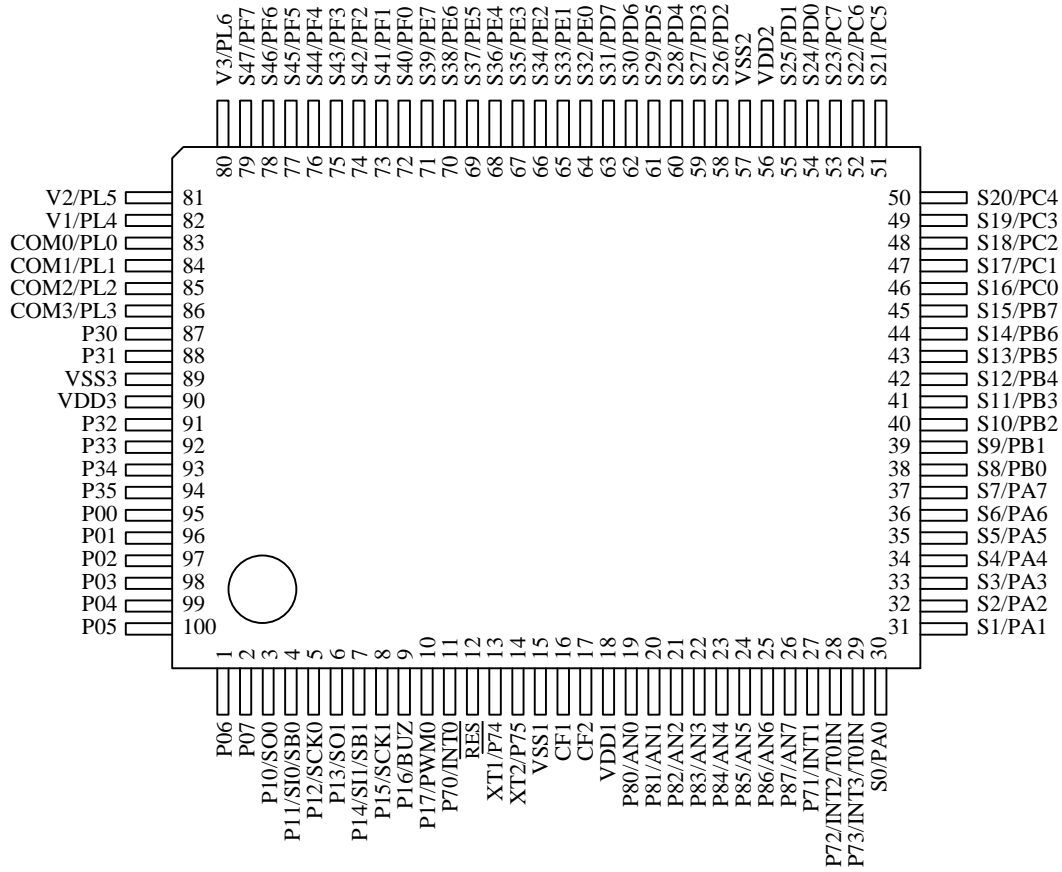
- Evaluation (EVA) chip : LC866093
- EPROM version : LC86E7248
- One time version : LC86P7248
- Emulator : EVA86000 + ECB867200 (Evaluation chip board) + POD866200 (Pod)

• Notes for use

Follow the under table

Frequency range of the system clock	Voltage range	Clock Divider	Note
15kHz to 30kHz	4.5V to 6.0V	1/1	Can not use 1/2 divider
30kHz to 6MHz		1/1, 1/2	
15kHz to 30kHz	2.5V to 6.0V	1/1	Can not use 1/2 divider
30kHz to 1.5MHz		1/1, 1/2	
1.5MHz to 3MHz		1/2	Can not use 1/1 divider
Internal RC oscillation	4.5V to 6.0V	1/1, 1/2	
	2.5V to 6.0V	1/2	Can not use 1/1 divider

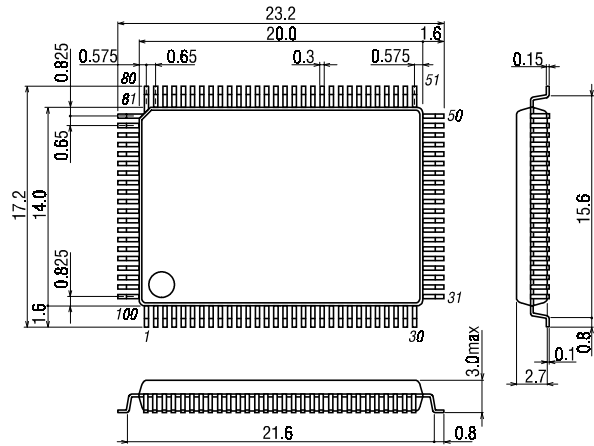
Pin Assignment



Package Dimension

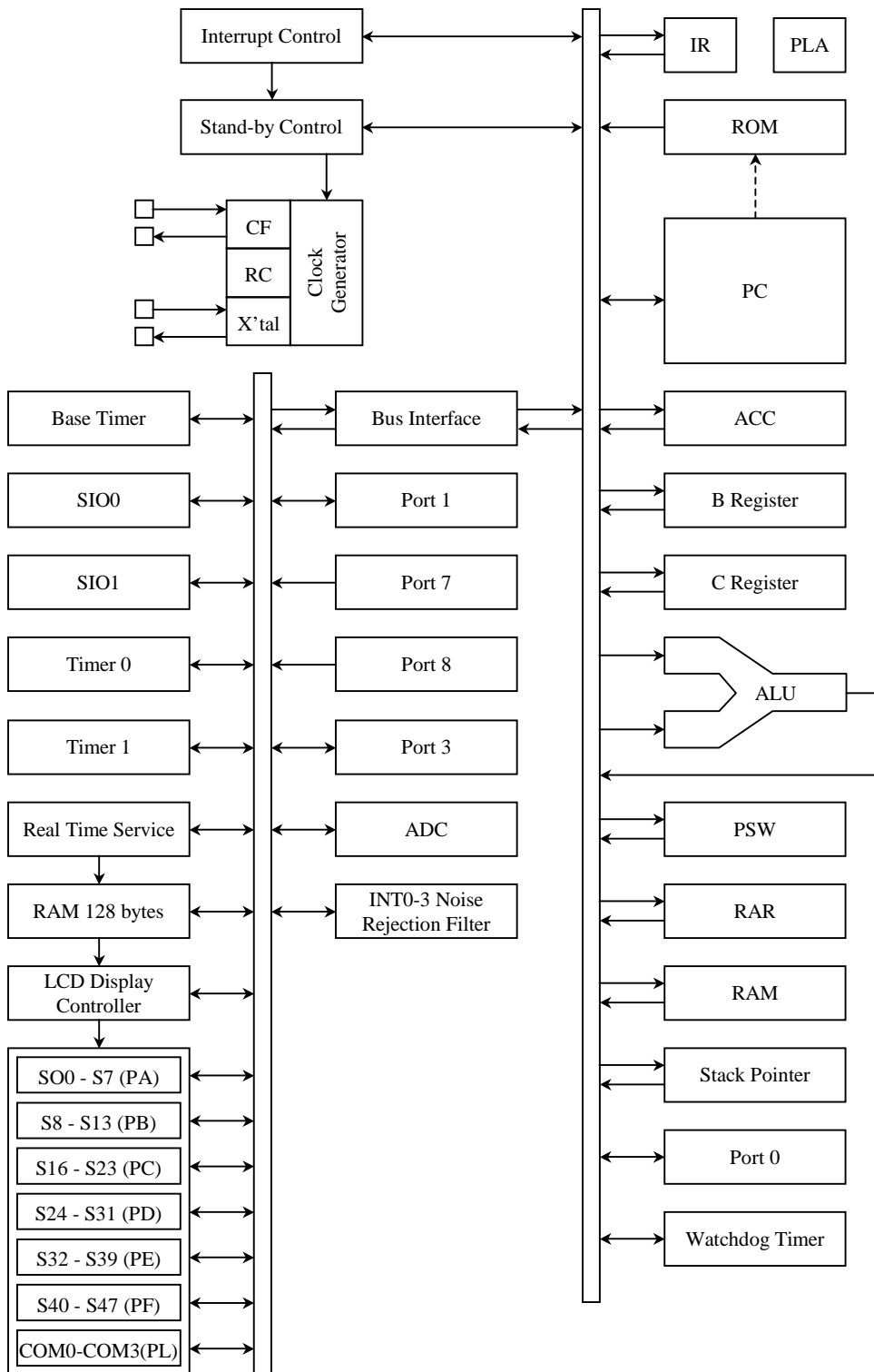
(unit : mm)

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SANYO : QIP-100E

System Block Diagram



Pin name	I/O	Function description	Option
PORT A (S0/PA0 – S7/PA7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT B (S8/PB0 – S15/PB7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT C (S16/PC0 – S23/PC7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT D (S24/PD0 – S31/PD7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT E (S32/PE0 – S39/PE7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT F (S40/PF0 – S47/PF7)	I/O	<ul style="list-style-type: none"> • Segment output terminal for LCD display • Can be used as a general input/output port 	-
PORT L (COM0/PL0 – COM3/PL7)	I/O	<ul style="list-style-type: none"> • Common output terminal for LCD display • Can be used as a general input port 	-
V1/PL4 – V3/PL6	I	<ul style="list-style-type: none"> • Bias power terminal for LCD drive • Can be used as a general input port 	-
$\overline{\text{RES}}$	I	Reset pin	-
XT1/ $\overline{\text{P74}}$	I	<ul style="list-style-type: none"> • Input pin for 32.768kHz crystal oscillation In case of non use, connect to VDD. • Other function A general input port $\overline{\text{P74}}$ 	-
XT2/P75	O	<ul style="list-style-type: none"> • Output pin for 32.768kHz crystal oscillation In case of non use, should be left unconnected • Other function A general input port P75 	-
CF1	I	Input pin for ceramic resonator oscillation	-
CF2	O	Output pin for ceramic resonator oscillation	-

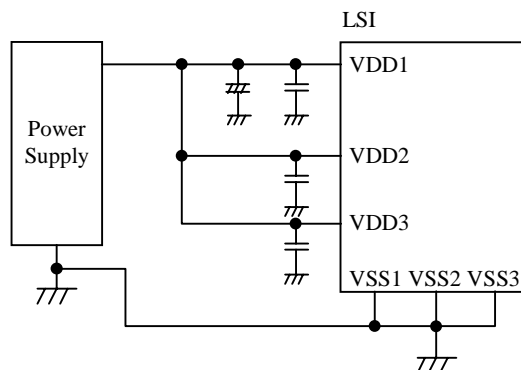
* All of port options can be specified in bit unit except the pull-up resistor of port 0.

* A state of pins at reset

Pin name	I/O mode	A state of pull-up resistor specified at pull-up option
Port 0	Input	Fixed pull-up resistor OFF
Port 1	Input	Programmable pull-up resistor OFF
Port 3	Input	Programmable pull-up resistor OFF
Ports 70, 71, 72, 73	Input	Fixed pull-up resistor OFF
XT1/ $\overline{\text{P74}}$, XT2/P75	Input	General input port as $\overline{\text{P74}}$, P75 (If using as the crystal oscillation, the specified register must be set.)

Pin name	I/O mode
Ports A, B, C, D, E, F	Output OFF

- [Notes]
- The VDD1, VDD2 and VDD3 terminals must be shorted electrically each other.
 - The VSS1, VSS2 and VSS3 terminals must be shorted electrically each other.
- * Connect like the following figure to reduce noise into a VDD terminals.



LC867248A/40A/32A/24A

1. Absolute Maximum Ratings at Ta=25°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
Supply voltage	VDDMAX	VDD1, VDD2 VDD3	VDD1=VDD2= VDD3		-0.3		+7.0	V
LCD display voltage	VLCD	V1/PL4, V2/PL5 V3/PL6	VDD1=VDD2= VDD3		-0.3		VDD	
Input voltage	VI	•Ports 71, 72, 73 •Ports 74, 75 •Port 8, Port L •RES			-0.3		VDD+0.3	
Input/output voltage	VIO	•Port 0, 1, 3 •Ports 70 •Ports A,B,C,D,E,F			-0.3		VDD+0.3	
High level output current	Peak output current	IOPH(1)	Ports 0, 1, 3	•CMOS output •At each pins		-4		mA
		IOPH(2)	Ports A,B,C,D,E,F			-4		
	Total output current	ΣIOAH(1)	Ports 0, 1, 32, 33, 34, 35	Total all pins		-38		
		ΣIOAH(2)	Ports 30, 31	Total all pins		-4		
		ΣIOAH(3)	Ports S0 to S25	Total all pins		-25		
		ΣIOAH(4)	Ports S26 to S47	Total all pins		-25		
Low level output current	Peak output current	IOPL(1)	Ports 0, 1, 3	At each pins			20	
		IOPL(2)	Ports A,B,C,D,E,F	At each pins			20	
		IOPL(3)	Port 70	At each pins			15	
	Total output current	ΣIOAL(1)	Ports 0, 1, 32, 33, 34, 35	Total all pins			50	
		ΣIOAL(2)	Ports 30, 31	Total all pins			20	
		ΣIOAL(3)	Ports S0 to S25	Total all pins			39	
		ΣIOAL(4)	Ports S26 to S47	Total all pins			33	
ΣIOAL(5)	Port 70	Total all pins			10			
Maximum power dissipation	Pdmax	QFP100E	Ta=-30 to+70°C				515	mW
Operating temperature range	Topr				-30		+70	°C
Storage temperature range	Tstg				-55		+125	

2. Recommended Operating range at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
Operating supply voltage range	VDD(1)	VDD1=VDD2=VDD3	0.98μs ≤ tCYC ≤ 400μs		4.5		6.0	V
	VDD(2)				2.5		6.0	
Hold voltage	VHD	VDD1=VDD2=VDD3	RAMs and the registers hold voltage at HOLD mode.		2.0		6.0	
Input high voltage	VIH(1)	Port 0	Output disable	2.5-6.0	0.4VDD+0.9		VDD	
	VIH(2)	•Ports 1, 3 •Ports A,B,C,D,E,F •Ports 72, 73	Output disable	2.5-6.0	0.75VDD		VDD	
	VIH(3)	•Port 70 Port input/interrupt •Port 71 •RES	Output N-channel Tr. OFF	2.5-6.0	0.75VDD		VDD	
	VIH(4)	Port 70 Watchdog timer	Output N-channel Tr. OFF	2.5-6.0	0.9VDD		VDD	
	VIH(5)	•Port 8 •Ports 74, 75	Using as port	2.5-6.0	0.75VDD		VDD	
Input low voltage	VIL(1)	Port 0	Output disable	2.5-6.0	VSS		0.2VDD	
	VIL(2)	•Ports 1, 3 •Ports A,B,C,D,E,F •Ports 72, 73	Output disable	2.5-6.0	VSS		0.25VDD	
	VIL(3)	•Port 70 Port input/interrupt •Port 71 •RES	Output N-channel Tr. OFF	2.5-6.0	VSS		0.25VDD	
	VIL(4)	Port 70 Watchdog timer	Output N-channel Tr. OFF	2.5-6.0	VSS		0.8VDD-1.0	
	VIL(5)	•Port 8 •Ports 74, 75	Using as port	2.5-6.0	VSS		0.25VDD	
Operation cycle time	tCYC			4.5-6.0	0.98		400	μs
				2.5-6.0	3.9		400	
Oscillation frequency range (Note 1)	FmCF(1)	CF1, CF2	•6MHz (ceramic resonator oscillation) •Refer to figure 1	4.5-6.0		6		MHz
	FmCF(2)	CF1, CF2	•3MHz (ceramic resonator oscillation) •Refer to figure 1	2.5-6.0		3		
	FmRC		RC oscillation	2.5-6.0	0.3	0.8	3.0	
	FsXtal	XT1, XT2	•32.768kHz (crystal oscillation) •Refer to figure 2	2.5-6.0		32.768		kHz
Oscillation stabilizing time period (Note 1)	tmsCF(1)	CF1, CF2	•6MHz (ceramic resonator oscillation) •Refer to figure 3	4.5-6.0				ms
	tmsCF(2)	CF1, CF2	•3MHz (ceramic resonator oscillation) •Refer to figure 3	4.5-6.0 2.5-6.0				
	tssXtal	XT1, XT2	•32.768kHz (crystal oscillation) •Refer to figure 3	4.5-6.0 2.5-6.0				s

(Note 1) The oscillation constant is shown on table 1 and table 2.

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3. Electrical Characteristics at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
Input high current	IIH(1)	•Port 1 •Port 0 without pull-up MOS Tr.	•Output disable •Pull-up MOS Tr. OFF. VIN=VDD (including the off-leak current of the output Tr.)	2.5-6.0			1	μA
	IIH(2)	•Port 7 without pull-up MOS Tr. •Port 8	VIN=VDD	2.5-6.0			1	
	IIH(3)	Port 3	VIN=VDD	2.5-6.0			1	
	IIH(4)	Ports A,B,C,D,E,F,L	VIN=VDD	2.5-6.0			1	
	IIH(5)	RES	VIN=VDD	2.5-6.0			1	
	IIH(6)	Ports 74,75	Using as port VIN=VDD	2.5-6.0			1	
Input low current	IIL(1)	•Port 1 •Port 0 without pull-up MOS Tr.	•Output disable •Pull-up MOS Tr. OFF. VIN=VSS (including the off-leak current of the output Tr.)	2.5-6.0	-1			μA
	IIL(2)	•Port 7 without pull-up MOS Tr. •Port 8	VIN=VSS	2.5-6.0	-1			
	IIL(3)	Port 3	VIN=VSS	2.5-6.0	-1			
	IIL(4)	Ports A,B,C,D,E,F,L	VIN=VSS	2.5-6.0	-1			
	IIL(5)	RES	VIN=VSS	2.5-6.0	-1			
	IIL(6)	Ports 74,75	Using as port VIN=VSS	2.5-6.0	-1			
Output high voltage	VOH(1)	Ports 0,1 of CMOS output	IOH=-1.0mA	4.5-6.0	VDD-1			V
	VOH(2)		IOH=-0.1mA	2.5-6.0	VDD-0.5			
	VOH(3)	•Port 3 of CMOS output	IOH=-1.0mA	4.5-6.0	VDD-1			
	VOH(4)	•Ports A,B,C,D,E,F of CMOS output	IOH=-0.1mA	2.5-6.0	VDD-0.5			
Output low voltage	VOL(1)	Ports 0, 1	IOL=10mA	4.5-6.0			1.5	
	VOL(2)		IOL=1.6mA	4.5-6.0			0.4	
	VOL(3)		•IOL=1mA •The current of any unmeasurement pin is not over 1 mA.	2.5-6.0			0.4	
	VOL(4)	Port 70	IOL=1mA	4.5-6.0			0.4	
	VOL(5)		IOL=0.5mA	2.5-6.0			0.4	
	VOL(6)	Port 3	IOL=10mA	4.5-6.0			1.5	
	VOL(7)		IOL=1.6mA	4.5-6.0			0.4	
	VOL(8)	Port 9	•IOL=1mA •The current of any unmeasurement pin is not over 1 mA.	2.5-6.0			0.4	
	VOL(9)	Ports A,B,C,D,E,F of CMOS output	IOL=8mA	4.5-6.0			1.5	
	VOL(10)		IOL=1.6mA	4.5-6.0			0.4	
	VOL(11)		•IOL=1mA •The current of any unmeasurement pin is not over 1 mA.	2.5-6.0			0.4	

Continue.

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
LCD output regulation	VODLS	S0 to S47	•Deference voltage to ideal value •VLCD, 2/3VLCD, 1/3VLCD	4.5-6.0	0		±0.2	V
				2.5-6.0	0		±0.2	
	VODLC	COM0 to COM3	•Deference voltage to ideal value •VLCD, 2/3VLCD, 1/2VLCD, 1/3VLCD	4.5-6.0	0		±0.2	
				2.5-6.0	0		±0.2	
LCD ladder resistor	PLCD(1)		Resistance at a ladder resistor	4.5-6.0		60		kΩ
				2.5-6.0		60		
	PLCD(2)		•Resistance at a ladder resistor •1/2R mode	4.5-6.0		30		
				2.5-6.0		30		
Pull-up MOS Tr. resistor	Rpu	•Ports 0, 1, 3 •Ports A,B,C,D,E,F •Ports 70, 71, 72, 73	VOH=0.9VDD	4.5-6.0	15	40	70	
				2.5-4.5	25	70	150	
Hysteresis voltage	VHIS	•Ports 1 •Ports 70, 71, 72, 73 •RES	Output disable	2.5-6.0		0.1VDD		V
Pin capacitance	CP	All pins	•f=1MHz •Unmeasurement terminals for the input are set to VSS level. •Ta=25°C	2.5-6.0		10		pF

4. Serial Input/Output Characteristics at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit			
				VDD[V]	min.	typ.		max.		
Serial clock	Input clock	Cycle	SCK0, SCK1	Refer to figure 5.	2.5-6.0	2			tCYC	
						Low Level pulse width	1			
							High Level pulse width	1		
	Output clock	Cycle	SCK0, SCK1	•Use pull-up resistor (1kΩ) when opendrain output. •Refer to figure 5.	2.5-6.0	2				
						Low Level pulse width		1/2 tCKCY		
							High Level pulse width			1/2 tCKCY
Serial input	Data set up time	•SI0,SI1 •SB0,SB1	•Data set-up to SCK0, 1 •Data hold from SCK0, 1 •Refer to figure 5.	4.5-6.0	0.1			μs		
				2.5-6.0	0.4					
	Data hold time			tCKI	4.5-6.0	0.1				
					2.5-6.0	0.4				
Serial output	Output delay time (Serial clock is external clock)	•SO0, SO1 •SB0, SB1	•Use pull-up resistor (1kΩ) when open drain output. •Data hold from SCK0, 1 •Refer to figure 5.	4.5-6.0			7/12tCYC +0.2			
				2.5-6.0			7/12tCYC +1			
	Output delay time (Serial clock is internal clock)			tCKO(2)	4.5-6.0				1/3tCYC +0.2	
					2.5-6.0				1/3tCYC +1	

5. Pulse Input Conditions at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit
				VDD[V]	min.	typ.	
High/low level pulse width	tPIH(1) tPIL(1)	•INT0, INT1 •INT2/T0IN	•Interrupt acceptable •Timer0-countable	2.5-6.0	1		tCYC
	tPIH(2) tPIL(2)	INT3/T0IN (The noise rejection clock is selected to 1/1.)	•Interrupt acceptable •Timer0-countable	2.5-6.0	2		
	tPIH(3) tPIL(3)	INT3/T0IN (The noise rejection clock is selected to 1/16.)	•Interrupt acceptable •Timer0-countable	2.5-6.0	32		
	tPIH(4) tPIL(4)	INT3/T0IN (The noise rejection clock is selected to 1/64.)	•Interrupt acceptable •Timer0-countable	2.5-6.0	128		
	tPIL(5)	RES	Reset acceptable	2.5-6.0	200		μs

6. AD converter Characteristics at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit
				VDD[V]	min.	typ.	
Resolution	NAD			4.5-6.0		8	bit
Absolute precision (Note 2)	ETAD			4.5-6.0			±1.5 LSB
Conversion time	tCAD		AD conversion time = 16 × tCYC (ADCR2=0) (Note 3)	4.5-6.0	15.68 (tCYC= 0.98μs)	65.28 (tCYC= 4.08μs)	μs
			AD conversion time = 32 × tCYC (ADCR2=1) (Note 3)		31.36 (tCYC= 0.98μs)	130.56 (tCYC= 4.08μs)	
Analog input voltage range	VAIN	AN0 - AN7		4.5-6.0	VSS	VDD	V
Analog port input current	IAINH		VAIN=VDD	4.5-6.0		1	μA
	IAINL		VAIN=VSS	4.5-6.0	-1		

(Note 2) Absolute precision excepts quantizing error (±1/2 LSB).

(Note 3) The conversion time means the time from executing the AD conversion instruction to setting the complete digital conversion value to the register.

7. Current Dissipation Characteristics at Ta=-30°C to +70°C, VSS=VSS1=VSS2=VSS3=0V

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
Current dissipation during basic operation (Note 4)	IDDOP(1)	VDD1= VDD2= VDD3	<ul style="list-style-type: none"> •FmCF=6MHz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/1 divided 	4.5-6.0		10	20	mA
	IDDOP(2)		<ul style="list-style-type: none"> •FmCF=3MHz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/2 divided 	4.5-6.0		3	11	
	IDDOP(3)		<ul style="list-style-type: none"> •FmCF=0Hz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/2 divided 	2.5-4.5		1.5	6	
	IDDOP(4)		<ul style="list-style-type: none"> •FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : RC oscillation •1/2 divided 	4.5-6.0		0.7	2.3	
	IDDOP(5)		<ul style="list-style-type: none"> •FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : RC oscillation •1/2 divided 	2.5-4.5		0.4	1.6	
	IDDOP(6)		<ul style="list-style-type: none"> •FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : crystal oscillation •Internal RC oscillation stops •1/2 divided 	4.5-6.0		35	130	
	IDDOP(7)		<ul style="list-style-type: none"> •FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : crystal oscillation •Internal RC oscillation stops •1/2 divided 	2.5-4.5		15	70	

Continue.

Parameter	Symbol	Pins	Conditions	Ratings			unit	
				VDD[V]	min.	typ.		max.
Current dissipation in HALT mode (Note 4)	IDDHALT(1)	VDD1= VDD2= VDD3	<ul style="list-style-type: none"> •HALT mode •FmCF=6MHz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/1 divided 	4.5-6.0		5	11	mA
	IDDHALT(2)		<ul style="list-style-type: none"> •HALT mode •FmCF=3MHz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/2 divided 	4.5-6.0		2.2	9	
	IDDHALT(3)		<ul style="list-style-type: none"> •HALT mode •FmCF=3MHz Ceramic resonator oscillation •FsXtal=32.768kHz crystal oscillation •System clock : CF oscillation •Internal RC oscillation stops •1/2 divided 	2.5-4.5		0.8	5	
	IDDHALT(4)		<ul style="list-style-type: none"> •HALT mode FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : RC oscillation •1/2 divided 	4.5-6.0		400	1100	μA
	IDDHALT(5)		<ul style="list-style-type: none"> •HALT mode FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : RC oscillation •1/2 divided 	2.5-4.5		200	700	
	IDDHALT(6)		<ul style="list-style-type: none"> •HALT mode FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : crystal oscillation •Internal RC oscillation stops •1/2 divided 	4.5-6.0		25	100	
	IDDHALT(7)		<ul style="list-style-type: none"> •HALT mode FmCF=0Hz (when oscillation stops) •FsXtal=32.768kHz crystal oscillation •System clock : crystal oscillation •Internal RC oscillation stops •1/2 divided 	2.5-4.5		8	55	
Current dissipation in HOLD mode (Note 4)	IDDHOLD(1)	VDD1= VDD2= VDD3	HOLD mode	4.5-6.0		0.05	30	
	IDDHOLD(2)			2.5-4.5		0.02	20	

(Note 4) The currents of the output transistors and the pull-up MOS transistors are ignored.

Table 1. Ceramic resonator oscillation recommended constant (main clock)

Oscillation type	Maker	Oscillator	C1	C2
6MHz ceramic resonator oscillation	Murata	CSA6.00MG	33pF	33pF
		CST6.00MGW	on chip	
3MHz ceramic resonator oscillation	Murata	CSA3.00MG	33pF	33pF
		CST3.00MGW	on chip	

* Both C1 and C2 must use K rank ($\pm 10\%$) and SL characteristics.

Table 2. Crystal oscillation guaranteed constant (sub clock)

Oscillation type	Maker	Oscillator	C3	C4	Rd
32.768kHz crystal oscillation	EPSON	C-002RX	15pF	15pF	680k Ω

* Both C3 and C4 must use J rank ($\pm 5\%$) and CH characteristics.

(It is about the application which is not in need of high precision. Use K rank ($\pm 10\%$) and SL characteristics.)

- (Notes)
- Since the circuit pattern affects the oscillation frequency, place the oscillation-related parts as close to the oscillation pins as possible with the shortest possible pattern length.
 - If you use other oscillators herein, we provide no guarantee for the characteristics.

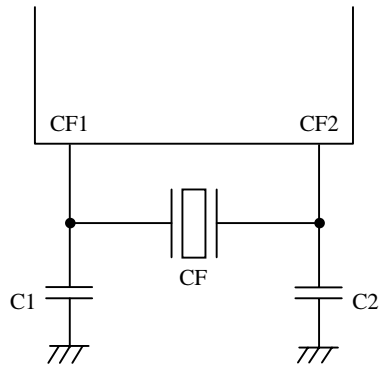


Figure 1 Ceramic oscillation circuit

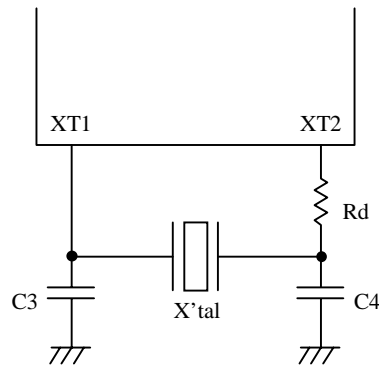


Figure 2 Crystal oscillation circuit

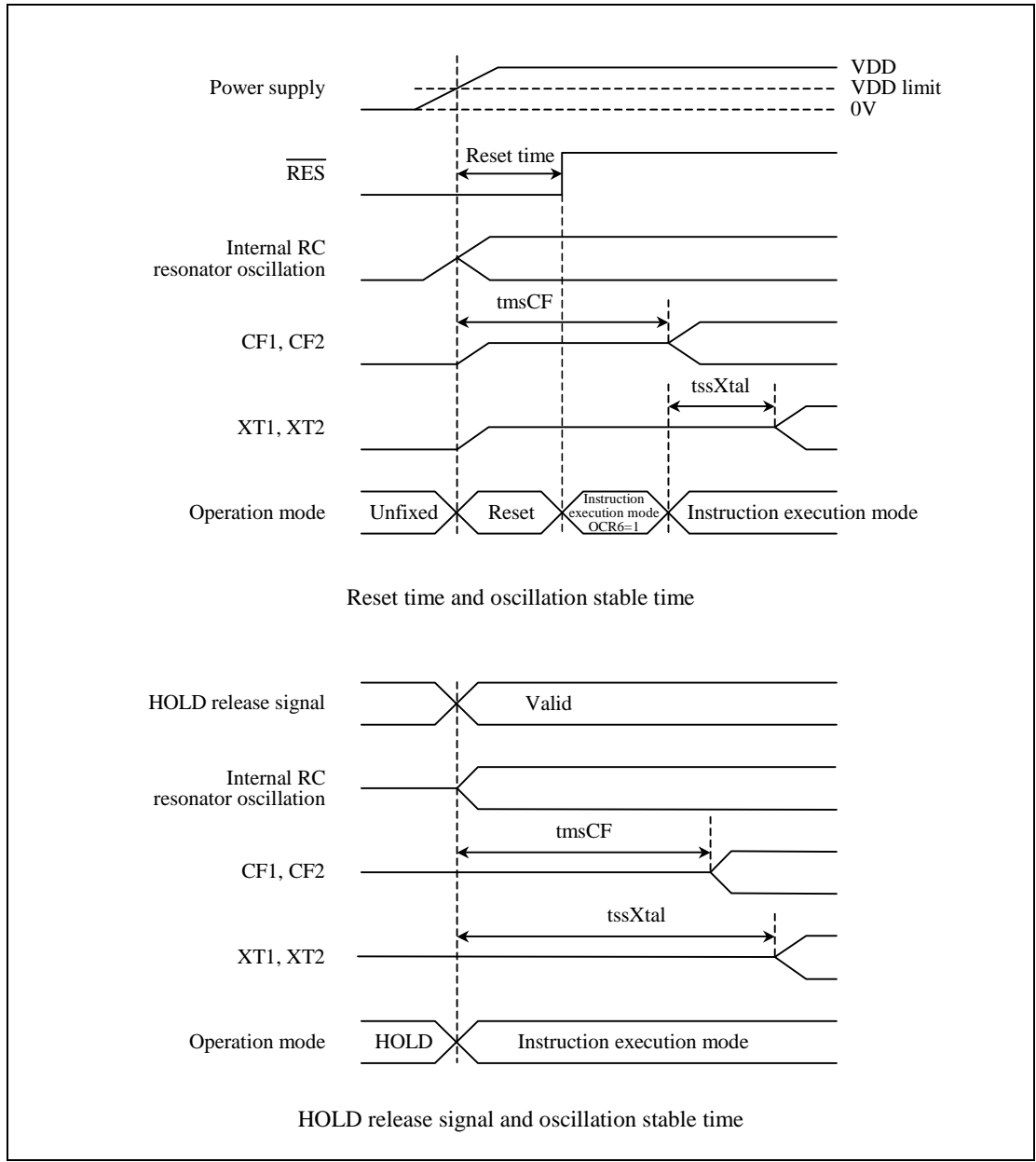
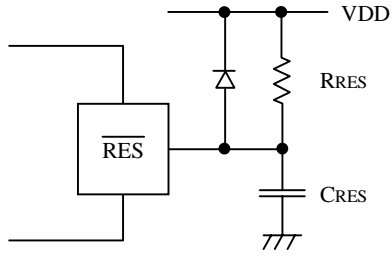


Figure 3 Oscillation stable time



(Note) Fix the value of CRES, RRES that is sure to reset until 200 μ s, after Power supply has been over inferior limit of supply voltage.

Figure 4 Reset circuit

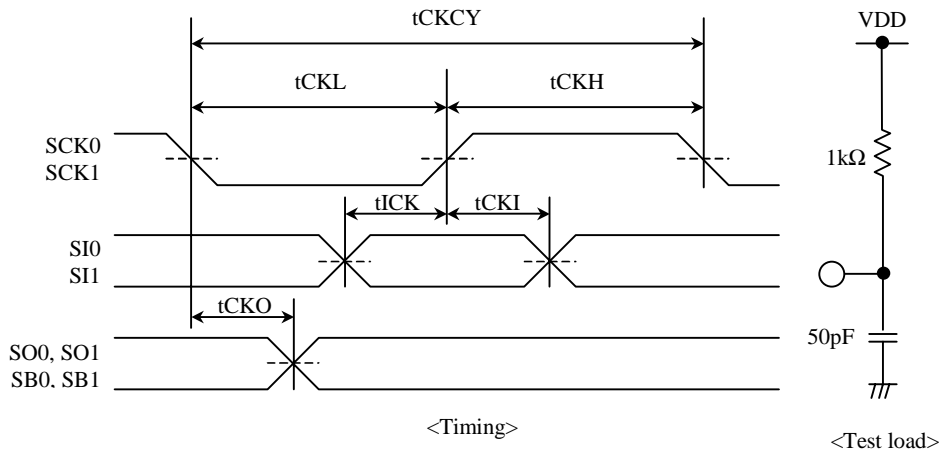
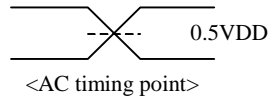


Figure 5 Serial input / output test condition

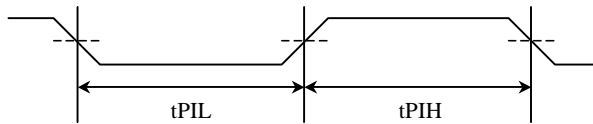


Figure 6 Pulse input timing condition

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